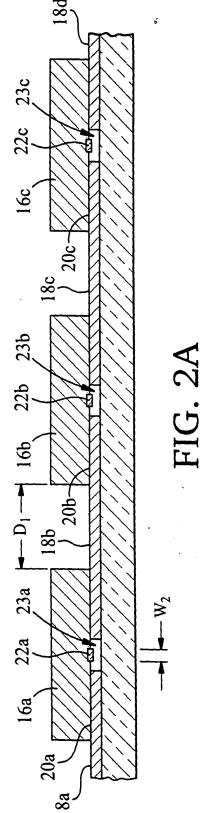
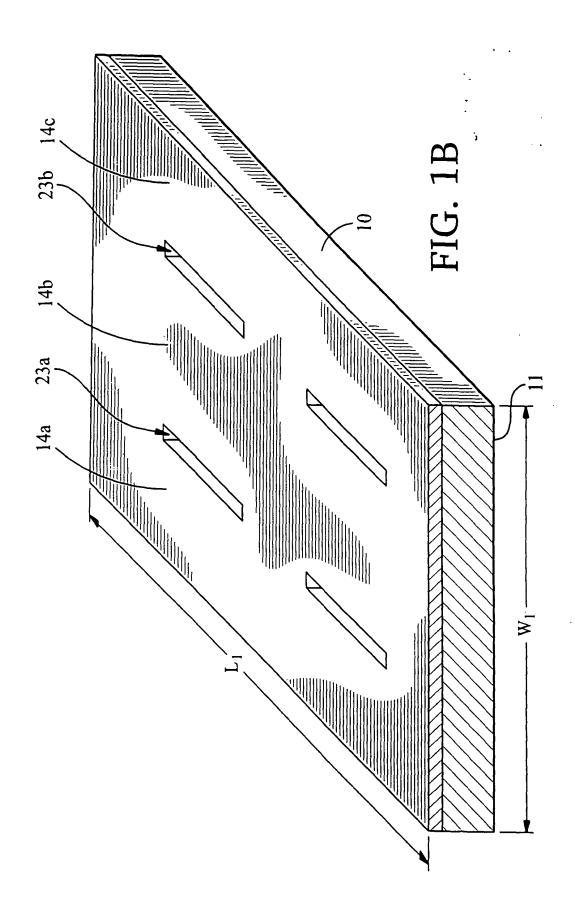
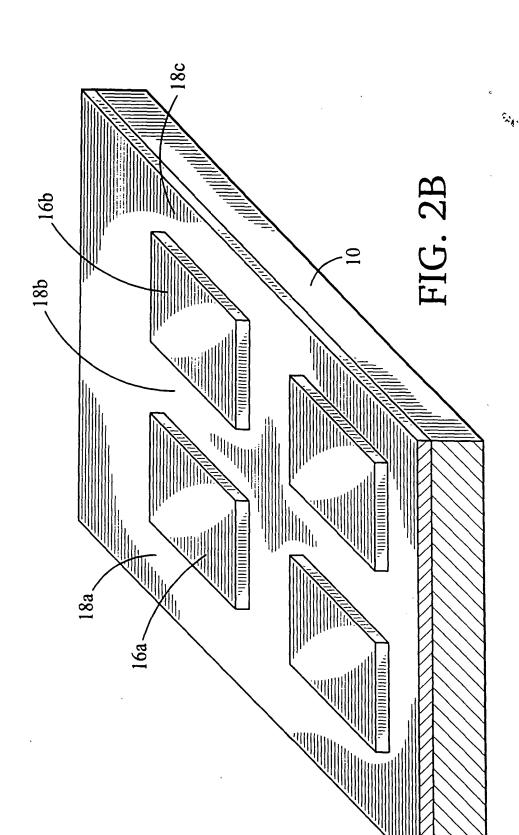


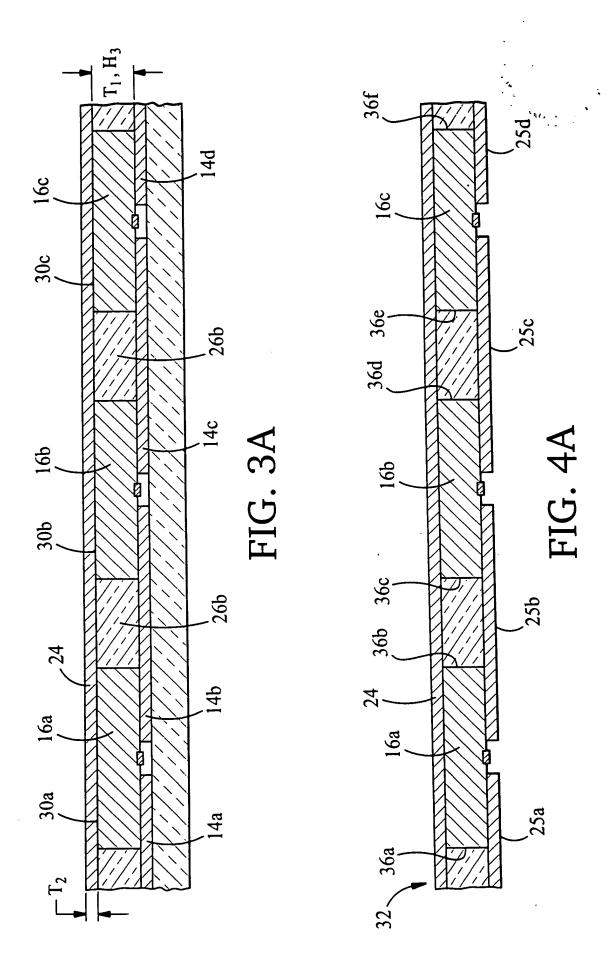
FIG. 1A





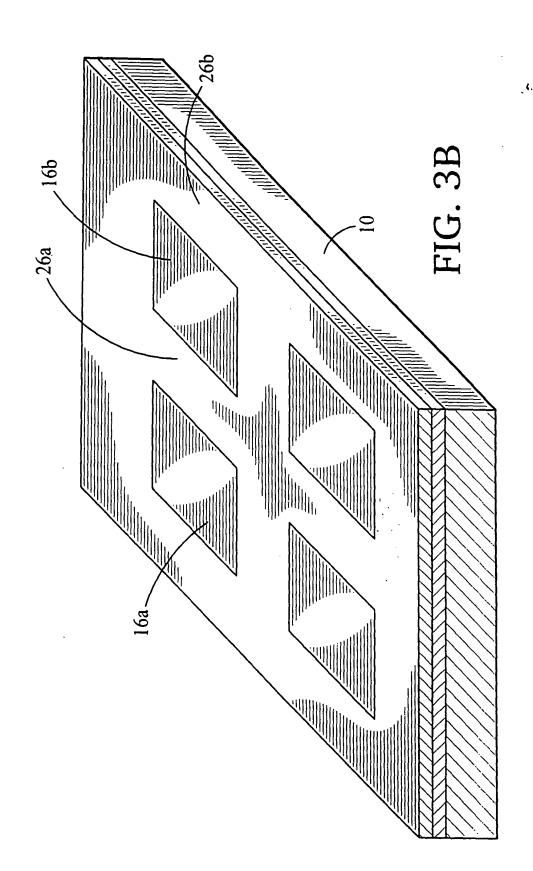
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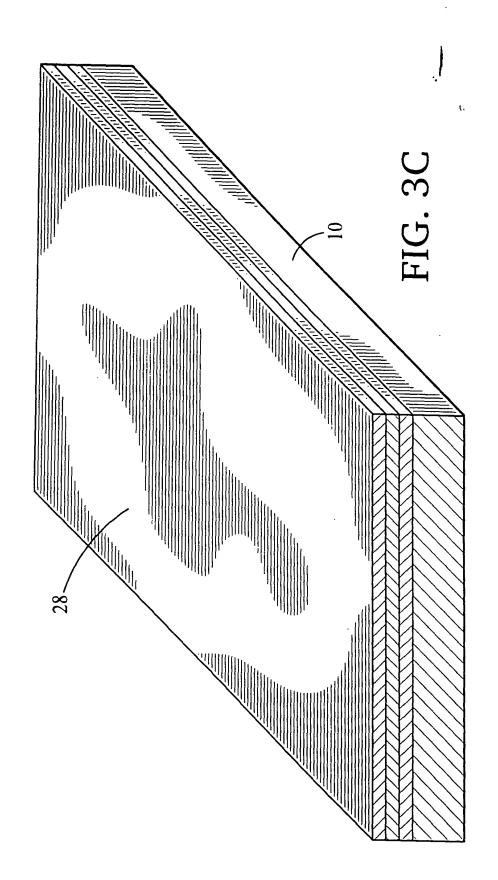


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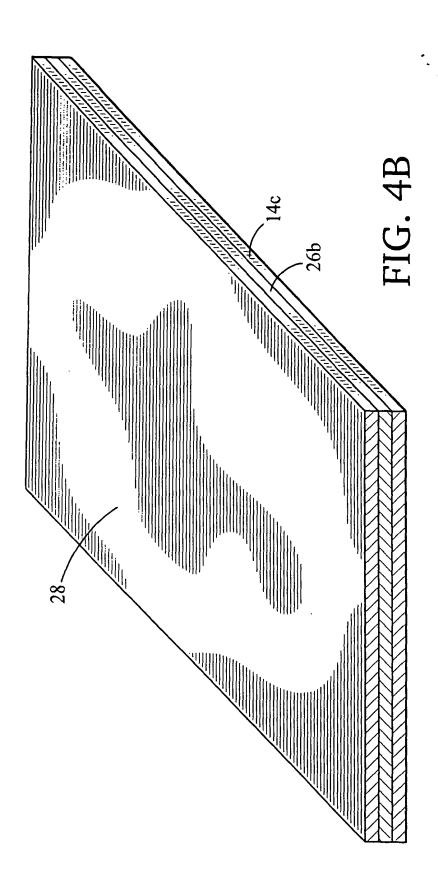


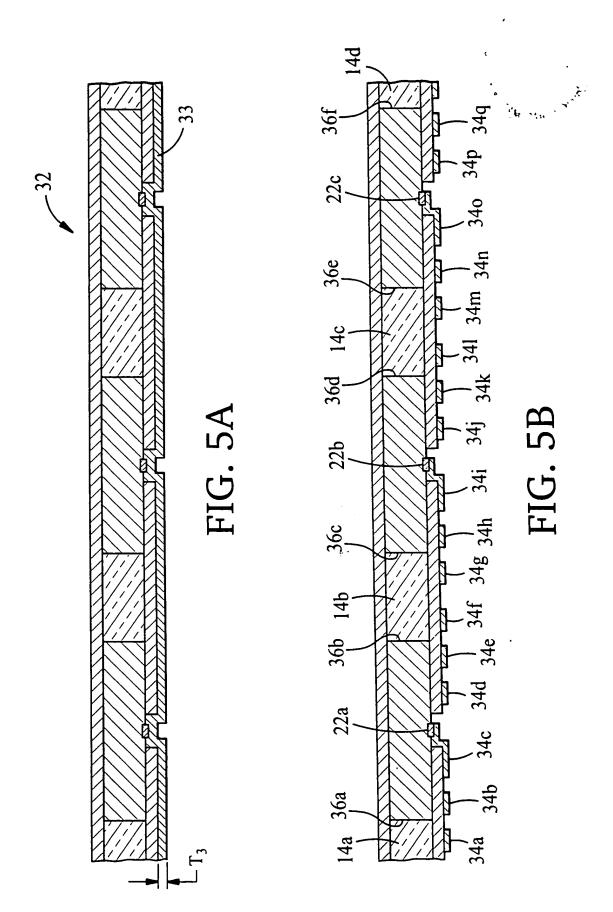
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Applicates: Harry Hedler et al.
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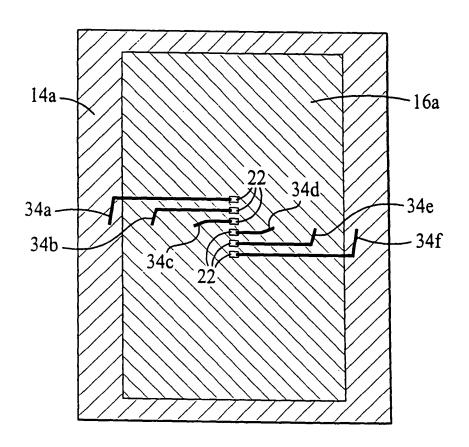


FIG. 5C

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FIG. 5D

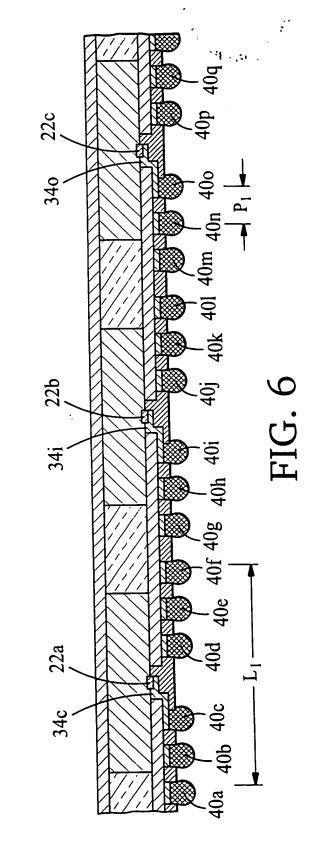
34m,34n,34o

34j,34k,34l

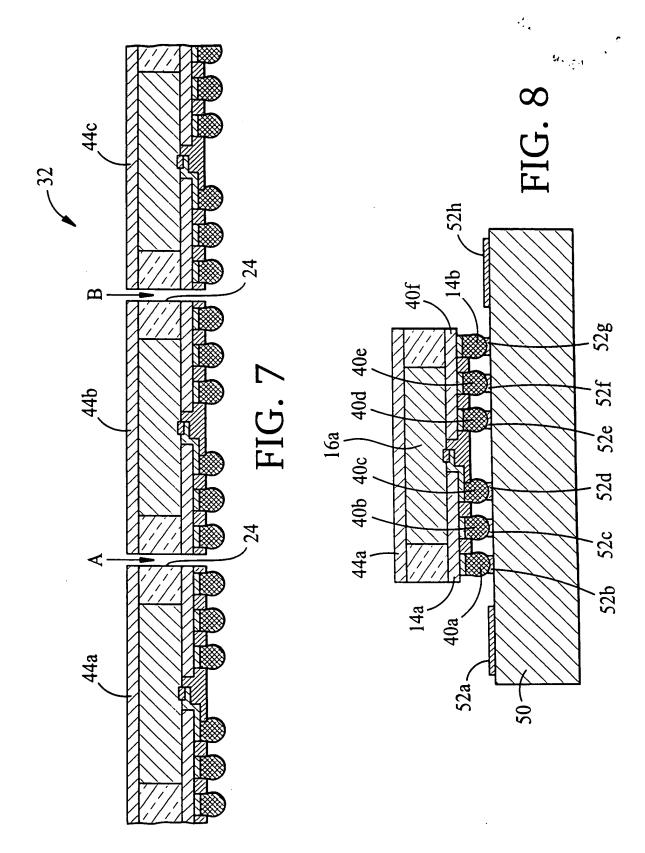
34g,34h,34i

34d,34e,34f

34a,34b,34c

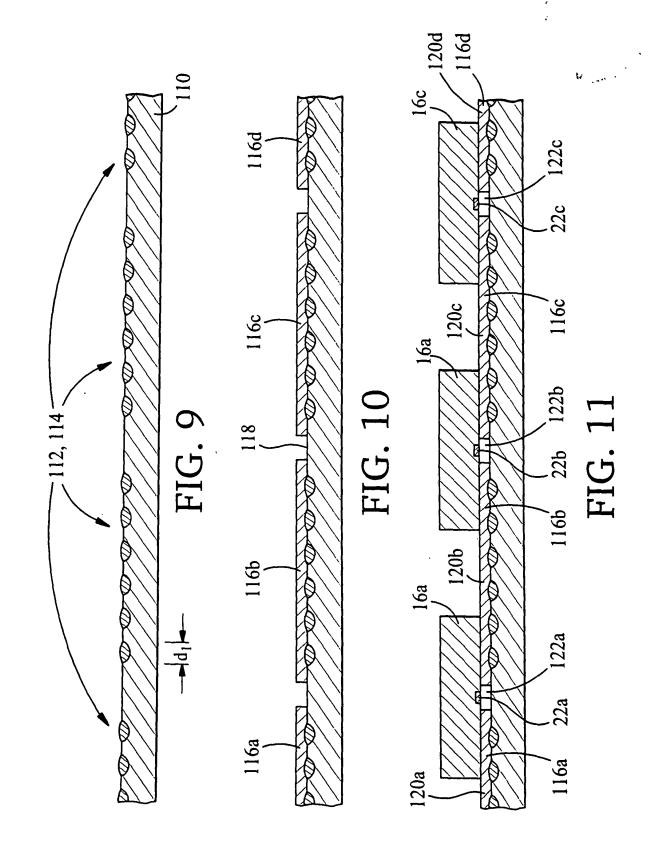


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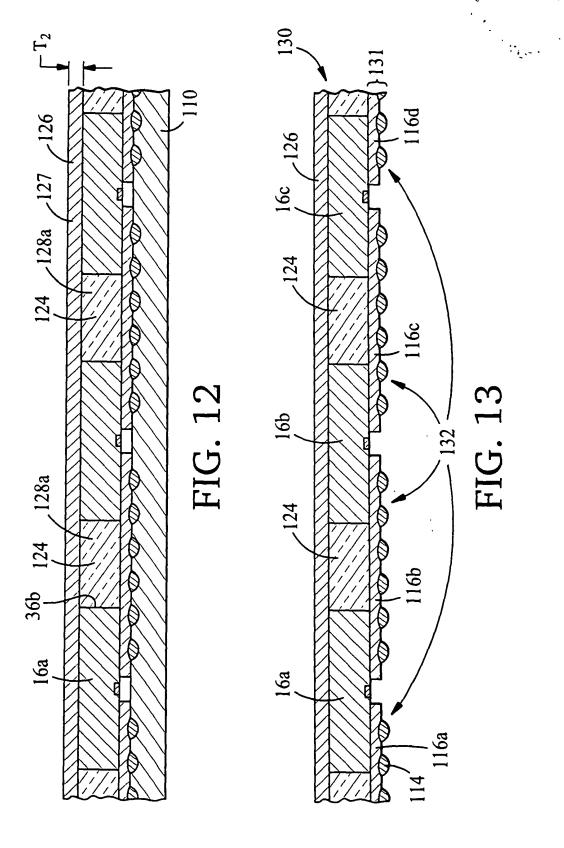


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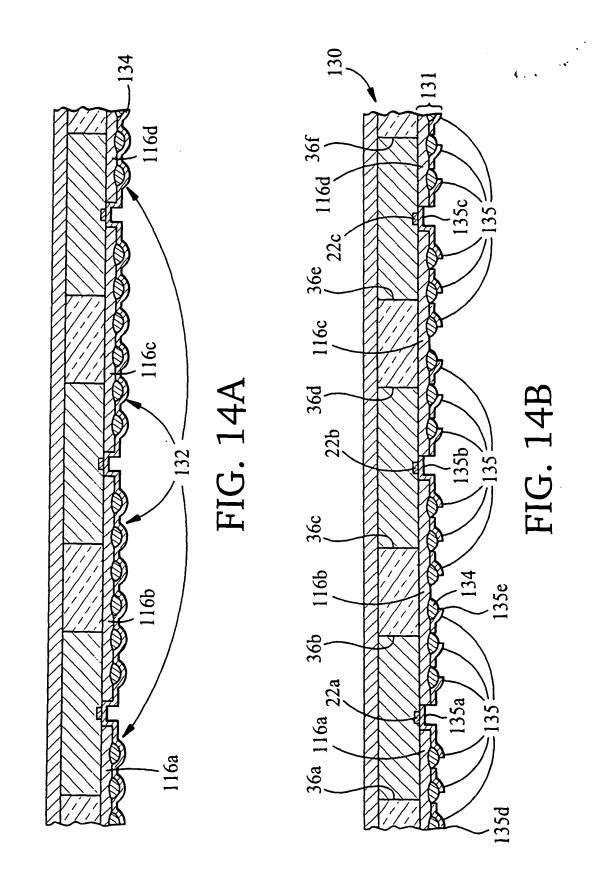


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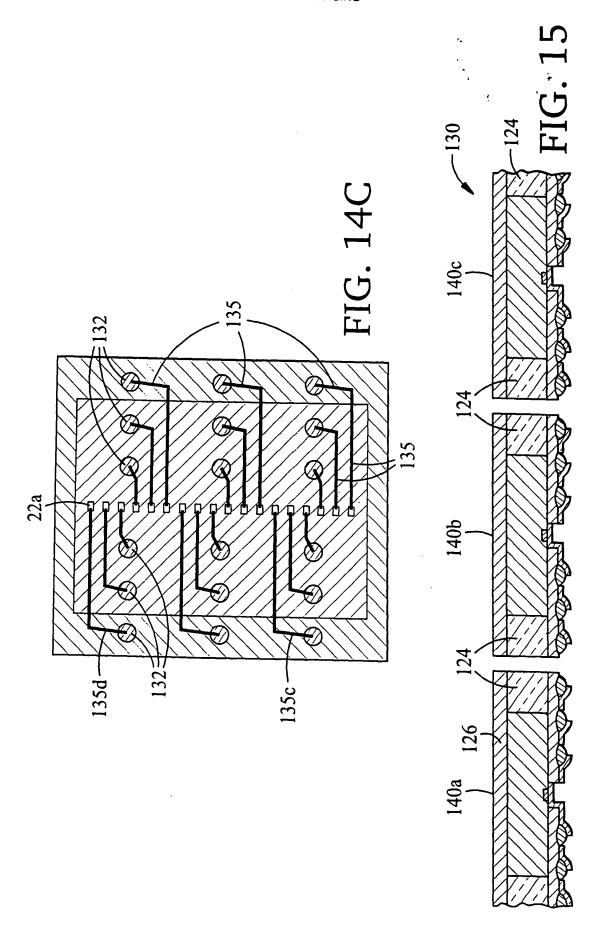
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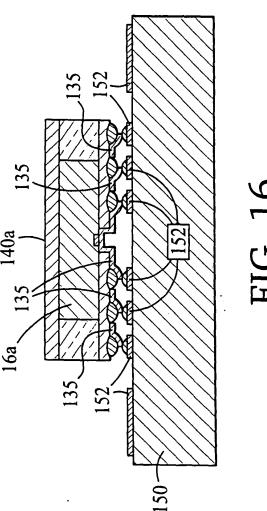
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ppln No.: 10/044,000
pplicant(s): Harry Hedler et al.
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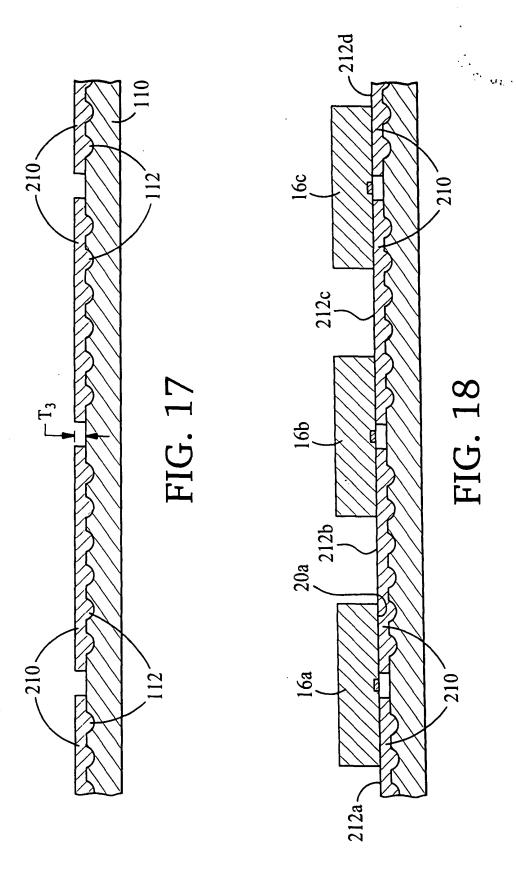
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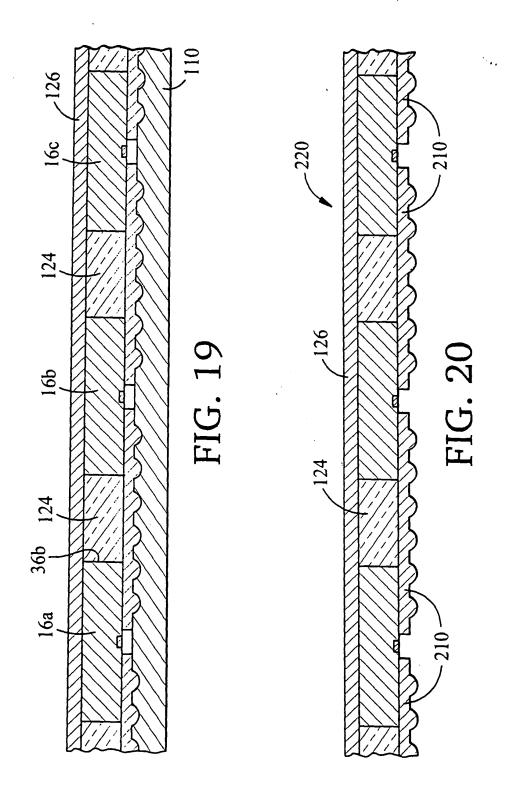




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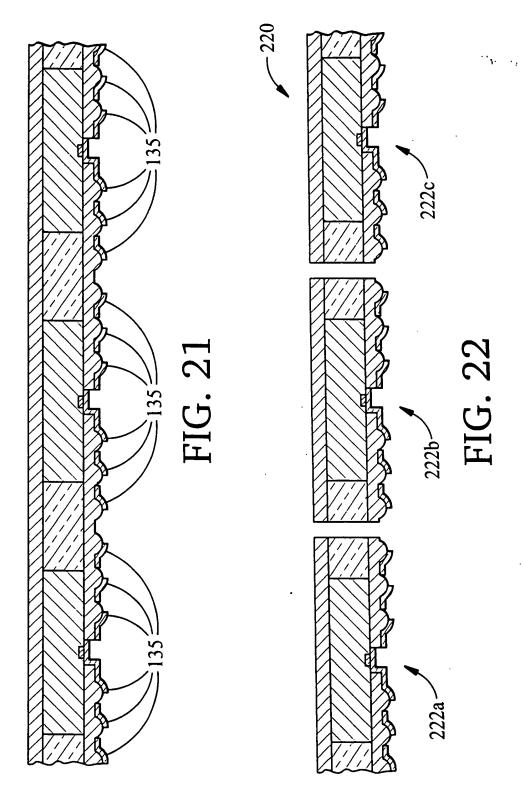




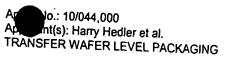
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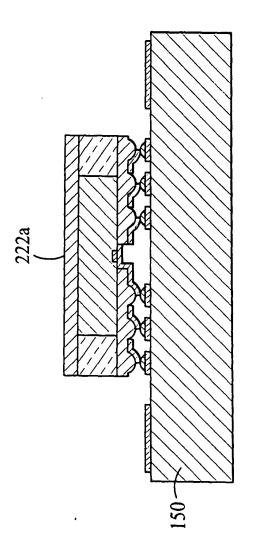


FIG. 23